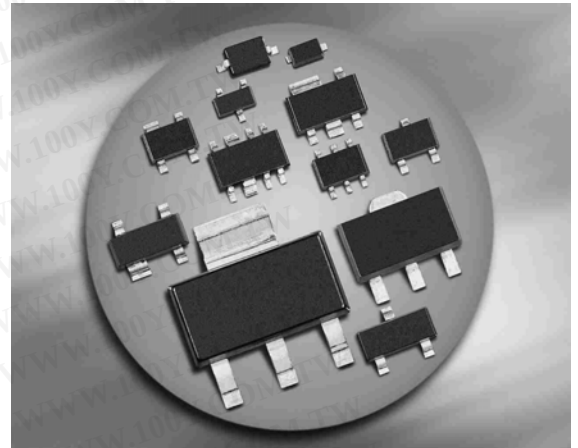


## NPN Silicon Switching Transistors

- High DC current gain: 0.1 mA to 100 mA
- Low collector-emitter saturation voltage
- For SMBT3904S:  
Two (galvanic) internal isolated transistors with good matching in one package
- Complementary types: SMBT3906... MMBT3906
- SMBT3904S: For orientation in reel  
see package information below
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



| Type              | Marking | Pin Configuration |      |      |      |      |      | Package |
|-------------------|---------|-------------------|------|------|------|------|------|---------|
| SMBT3904/MMBT3904 | s1A     | 1=B               | 2=E  | 3=C  | -    | -    | -    | SOT23   |
| SMBT3904S         | s1A     | 1=E1              | 2=B1 | 3=C2 | 4=E2 | 5=B2 | 6=C1 | SOT363  |

## Maximum Ratings

| Parameter                                                                 | Symbol    | Value       | Unit             |
|---------------------------------------------------------------------------|-----------|-------------|------------------|
| Collector-emitter voltage                                                 | $V_{CEO}$ | 40          | V                |
| Collector-base voltage                                                    | $V_{CBO}$ | 60          |                  |
| Emitter-base voltage                                                      | $V_{EBO}$ | 6           |                  |
| Collector current                                                         | $I_C$     | 200         | mA               |
| Total power dissipation-<br>$T_S \leq 71^\circ\text{C}$ , SOT23, SMBT3904 | $P_{tot}$ | 330         | mW               |
| $T_S \leq 115^\circ\text{C}$ , SOT363, SMBT3904S                          |           | 250         |                  |
| Junction temperature                                                      | $T_j$     | 150         | $^\circ\text{C}$ |
| Storage temperature                                                       | $T_{stg}$ | -65 ... 150 |                  |

## Thermal Resistance

| Parameter                                | Symbol     | Value      | Unit |
|------------------------------------------|------------|------------|------|
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ |            | K/W  |
| SMBT3904/MMBT3904                        |            | $\leq 240$ |      |
| SMBT3904S                                |            | $\leq 140$ |      |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

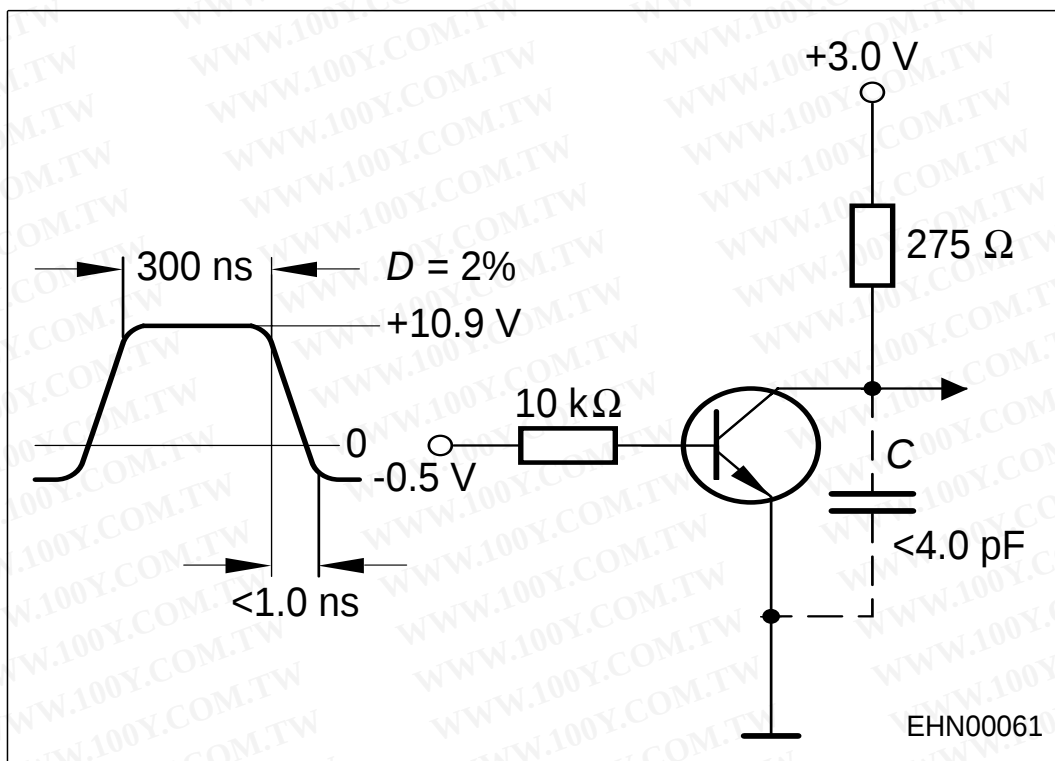
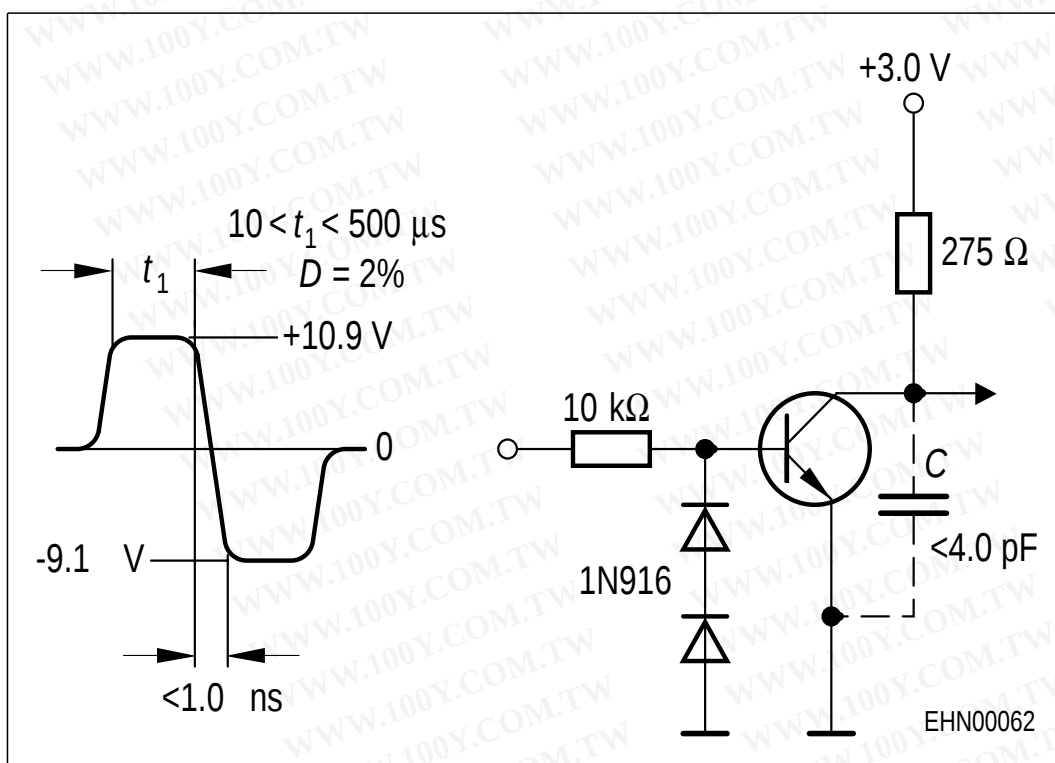
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                                                                                                                                                                                                                                | Symbol        | Values                      |                       |                         | Unit |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|-----------------------------|-----------------------|-------------------------|------|
|                                                                                                                                                                                                                                                                          |               | min.                        | typ.                  | max.                    |      |
| DC Characteristics                                                                                                                                                                                                                                                       |               |                             |                       |                         |      |
| Collector-emitter breakdown voltage<br>$I_C = 1\text{ mA}, I_B = 0$                                                                                                                                                                                                      | $V_{(BR)CEO}$ | 40                          | -                     | -                       | V    |
| Collector-base breakdown voltage<br>$I_C = 10\text{ }\mu\text{A}, I_E = 0$                                                                                                                                                                                               | $V_{(BR)CBO}$ | 60                          | -                     | -                       |      |
| Emitter-base breakdown voltage<br>$I_E = 10\text{ }\mu\text{A}, I_C = 0$                                                                                                                                                                                                 | $V_{(BR)EBO}$ | 6                           | -                     | -                       |      |
| Collector-base cutoff current<br>$V_{CB} = 30\text{ V}, I_E = 0$                                                                                                                                                                                                         | $I_{CBO}$     | -                           | -                     | 50                      | nA   |
| DC current gain <sup>1)</sup><br>$I_C = 100\text{ }\mu\text{A}, V_{CE} = 1\text{ V}$<br>$I_C = 1\text{ mA}, V_{CE} = 1\text{ V}$<br>$I_C = 10\text{ mA}, V_{CE} = 1\text{ V}$<br>$I_C = 50\text{ mA}, V_{CE} = 1\text{ V}$<br>$I_C = 100\text{ mA}, V_{CE} = 1\text{ V}$ | $h_{FE}$      | 40<br>70<br>100<br>60<br>30 | -<br>-<br>-<br>-<br>- | -<br>-<br>300<br>-<br>- | -    |
| Collector-emitter saturation voltage <sup>1)</sup><br>$I_C = 10\text{ mA}, I_B = 1\text{ mA}$<br>$I_C = 50\text{ mA}, I_B = 5\text{ mA}$                                                                                                                                 | $V_{CEsat}$   | -<br>-                      | -<br>-                | 0.2<br>0.3              | V    |
| Base emitter saturation voltage <sup>1)</sup><br>$I_C = 10\text{ mA}, I_B = 1\text{ mA}$<br>$I_C = 50\text{ mA}, I_B = 5\text{ mA}$                                                                                                                                      | $V_{BEsat}$   | 0.65<br>-                   | -<br>-                | 0.85<br>0.95            |      |

<sup>1)</sup>Pulse test:  $t < 300\text{ }\mu\text{s}$ ;  $D < 2\%$

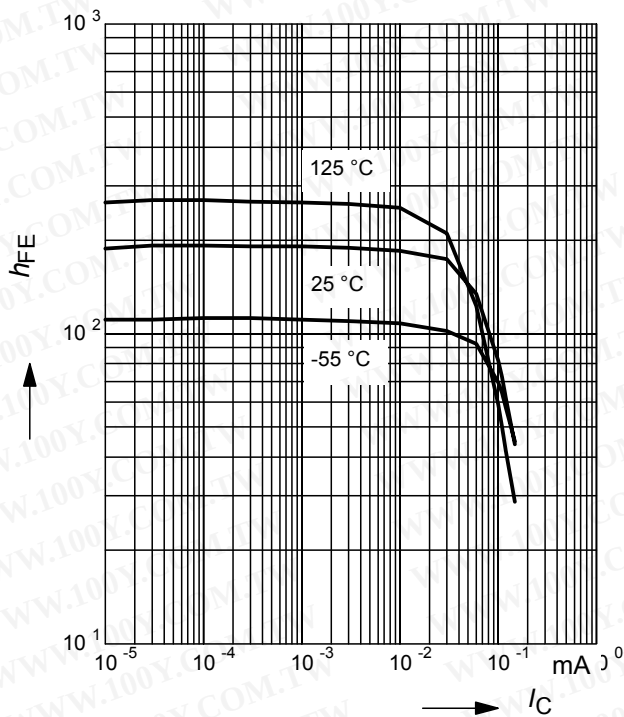
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                                                                                                              | Symbol    | Values |      |      | Unit |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|--------|------|------|------|
|                                                                                                                                                        |           | min.   | typ. | max. |      |
| AC Characteristics                                                                                                                                     |           |        |      |      |      |
| Transition frequency<br>$I_C = 10\text{ mA}$ , $V_{CE} = 20\text{ V}$ , $f = 100\text{ MHz}$                                                           | $f_T$     | 300    | -    | -    | MHz  |
| Collector-base capacitance<br>$V_{CB} = 5\text{ V}$ , $f = 1\text{ MHz}$                                                                               | $C_{cb}$  | -      | -    | 3.5  | pF   |
| Emitter-base capacitance<br>$V_{EB} = 0.5\text{ V}$ , $f = 1\text{ MHz}$                                                                               | $C_{eb}$  | -      | -    | 8    |      |
| Delay time<br>$V_{CC} = 3\text{ V}$ , $I_C = 10\text{ mA}$ , $I_{B1} = 1\text{ mA}$ ,<br>$V_{BE(off)} = 0.5\text{ V}$                                  | $t_d$     | -      | -    | 35   | ns   |
| Rise time<br>$V_{CC} = 3\text{ V}$ , $I_C = 10\text{ mA}$ , $I_{B1} = 1\text{ mA}$ ,<br>$V_{BE(off)} = 0.5\text{ V}$                                   | $t_r$     | -      | -    | 35   |      |
| Storage time<br>$V_{CC} = 3\text{ V}$ , $I_C = 10\text{ mA}$ , $I_{B1} = I_{B2} = 1\text{ mA}$                                                         | $t_{stg}$ | -      | -    | 200  |      |
| Fall time<br>$V_{CC} = 3\text{ V}$ , $I_C = 10\text{ mA}$ , $I_{B1} = I_{B2} = 1\text{ mA}$                                                            | $t_f$     | -      | -    | 50   |      |
| Noise figure<br>$I_C = 100\text{ }\mu\text{A}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$ ,<br>$\Delta f = 200\text{ Hz}$ , $R_S = 1\text{ k}\Omega$ | $F$       | -      | -    | 5    | dB   |

**Test circuits**
**Delay and rise time**

**Storage and fall time**


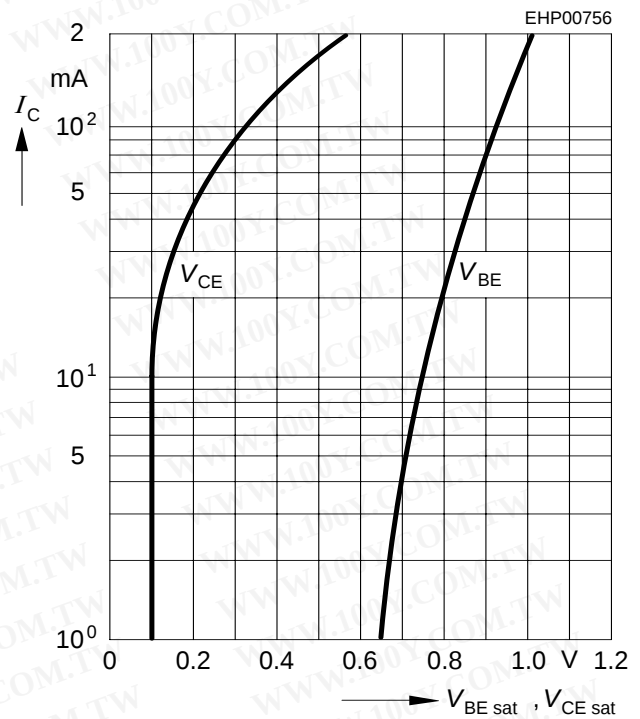
**DC current gain**  $h_{FE} = f(I_C)$

$V_{CE} = 1 \text{ V}$ , normalized



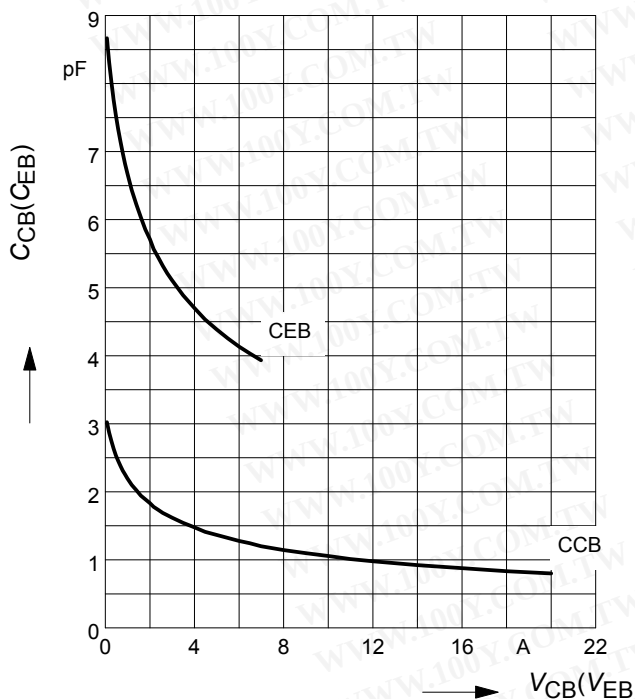
**Saturation voltage**  $I_C = f(V_{BEsat}; V_{CEsat})$

$h_{FE} = 10$



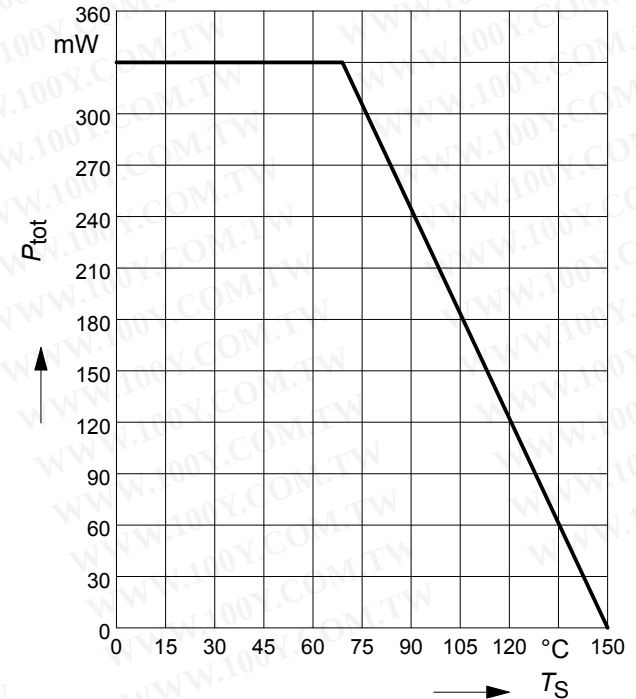
**Collector-base capacitance**  $C_{cb} = f(V_{CB})$

**Emitter-base capacitance**  $C_{eb} = f(V_{EB})$



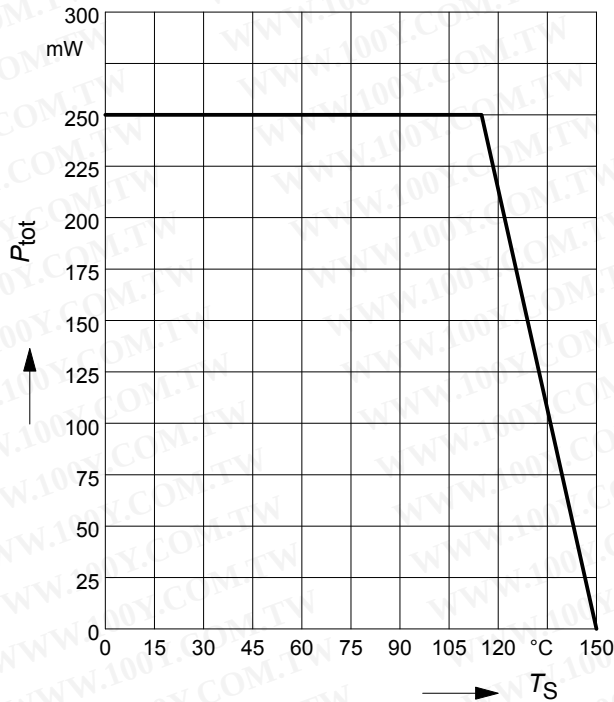
**Total power dissipation**  $P_{tot} = f(T_S)$

SMBT3904/MMBT3904



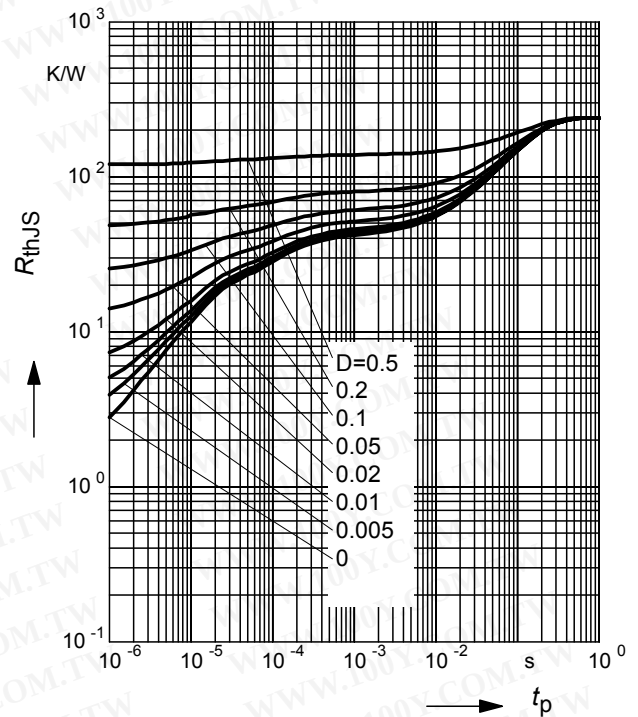
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

SMBT3904S



**Permissible Pulse Load  $R_{\text{thJS}} = f(t_p)$**

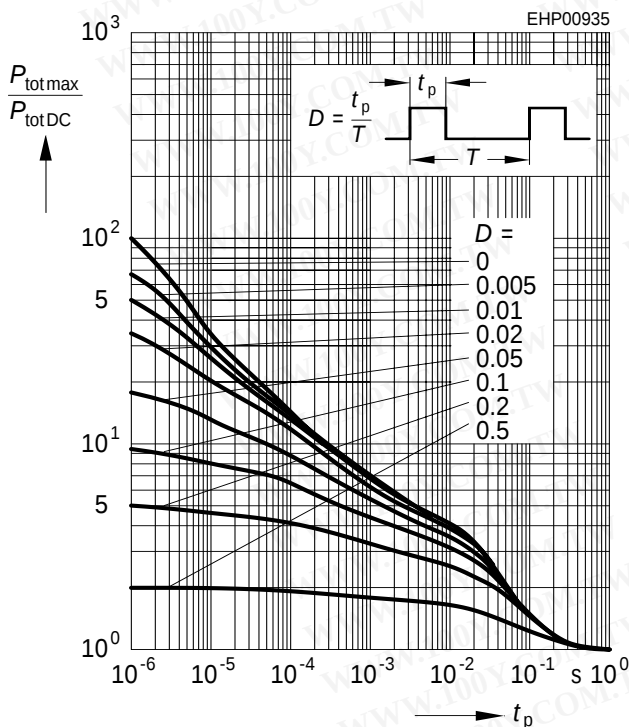
SMBT3904/ MMBT3904



**Permissible Pulse Load**

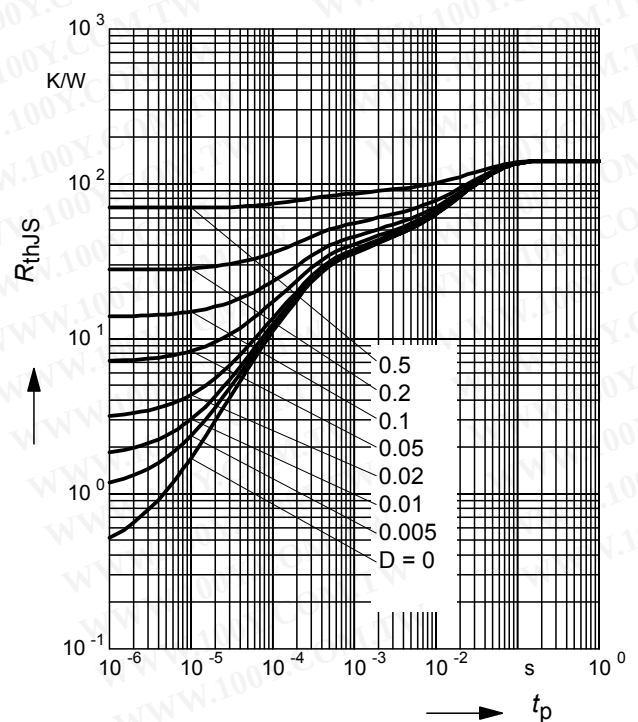
$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$

SMBT3904/MMBT3904



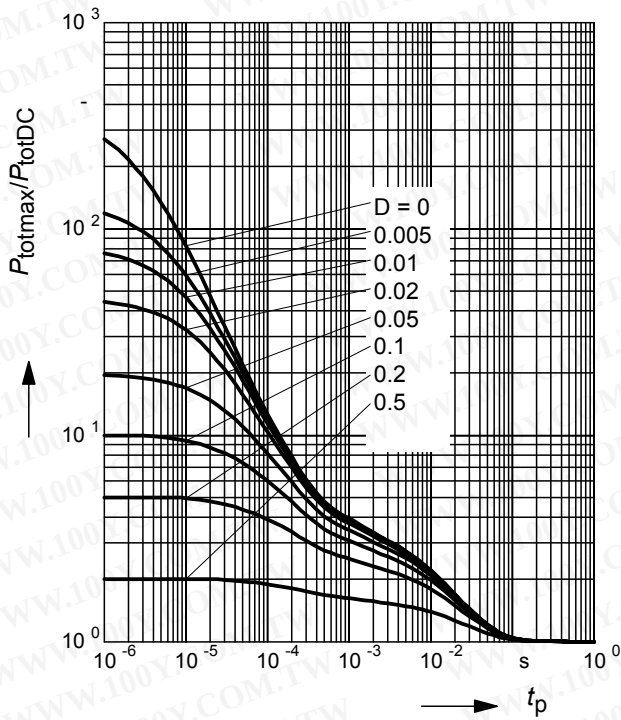
**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$**

SMBT3904S



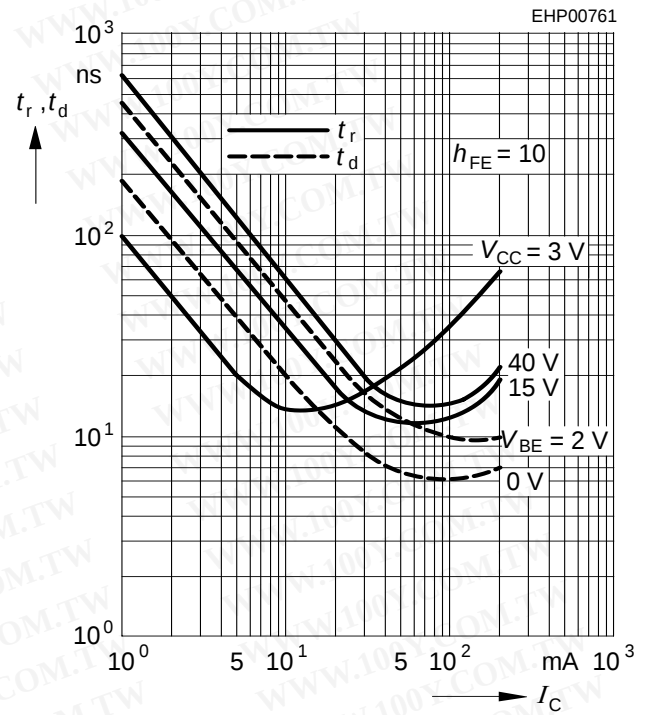
**Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

**SMBT3904S**


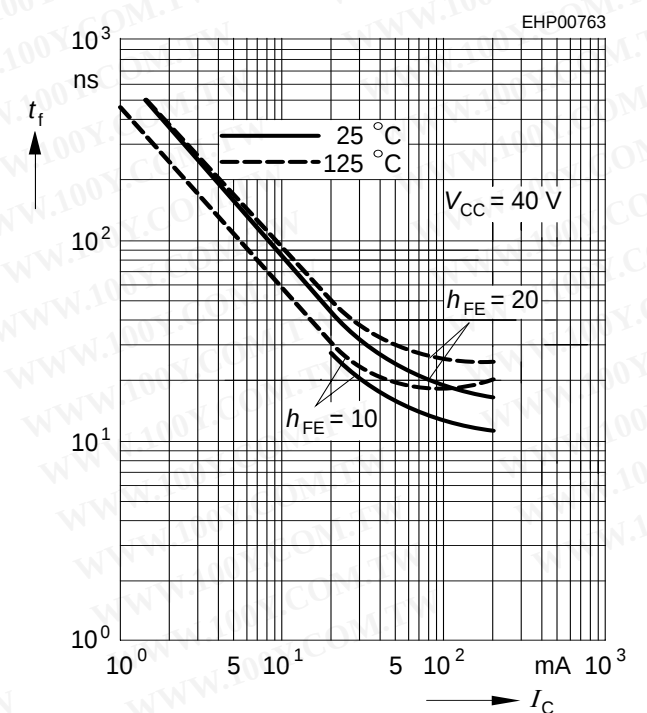
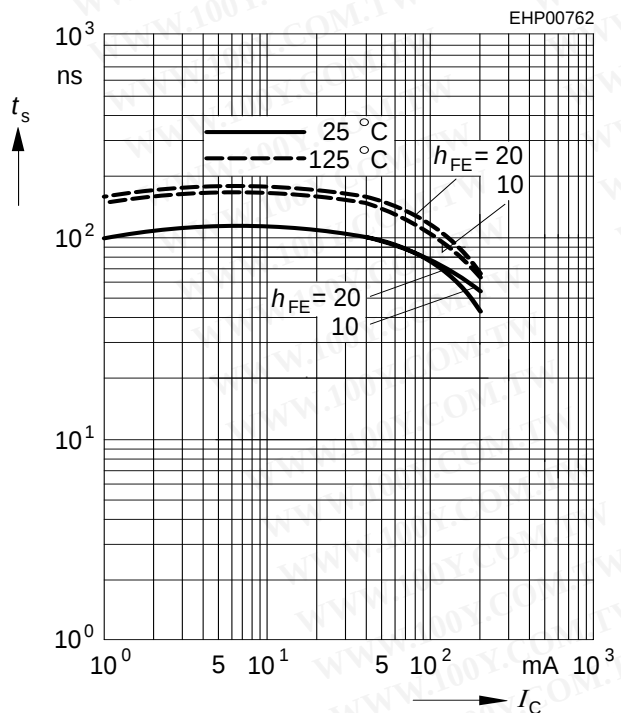
**Delay time  $t_d = f(I_C)$**

**Rise time  $t_r = f(I_C)$**

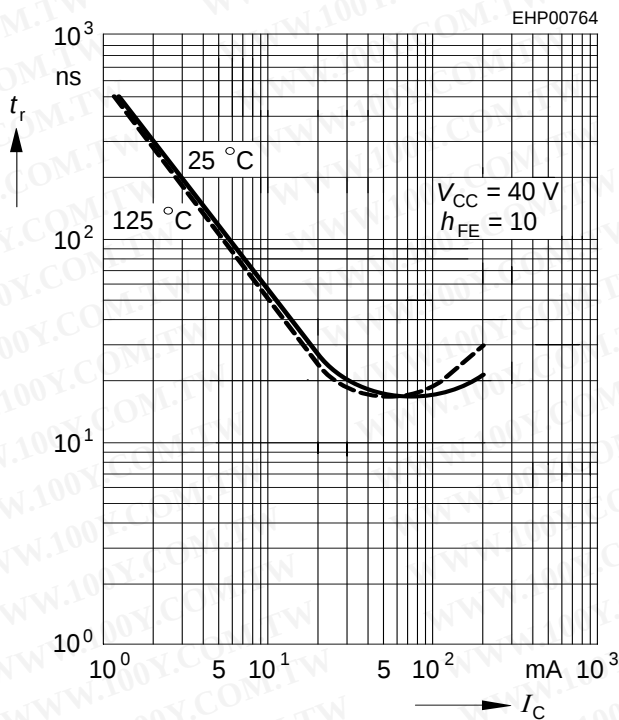


**Storage time  $t_{\text{stg}} = f(I_C)$**

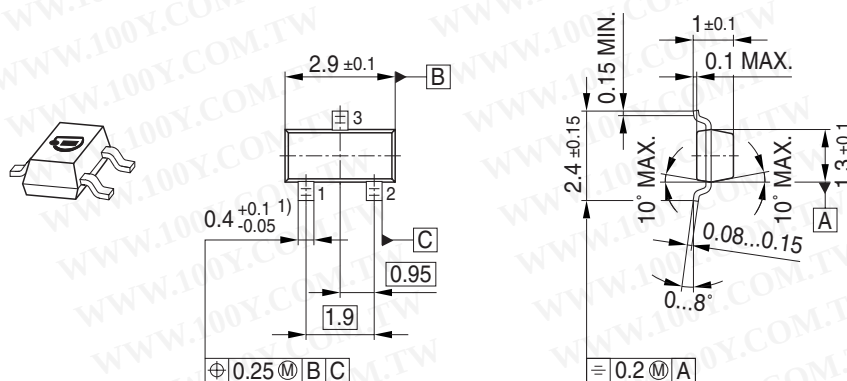
**Fall time  $t_f = f(I_C)$**



Rise time  $t_r = f(I_C)$

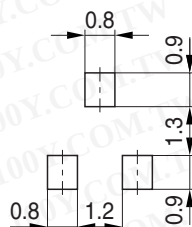


## Package Outline

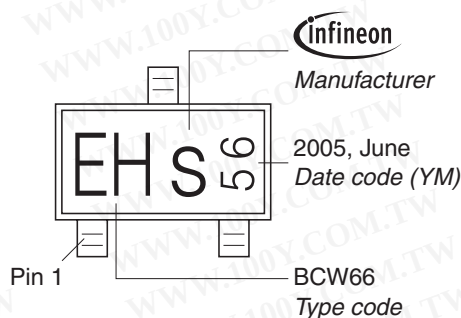


1) Lead width can be 0.6 max. in dambar area

## Foot Print

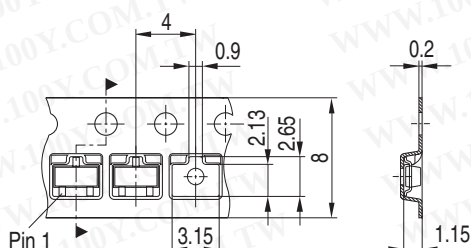


## Marking Layout (Example)

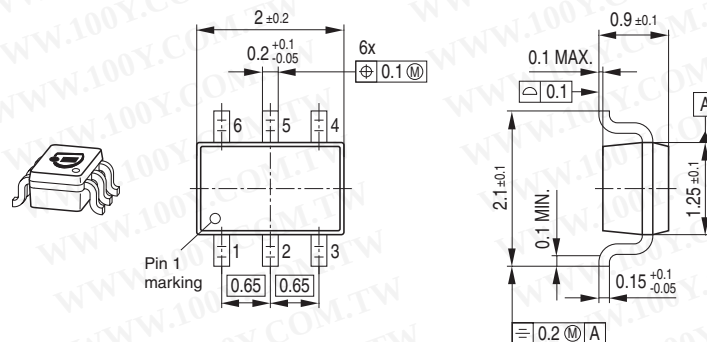


## Standard Packing

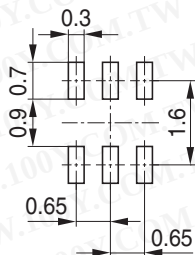
Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



## Package Outline

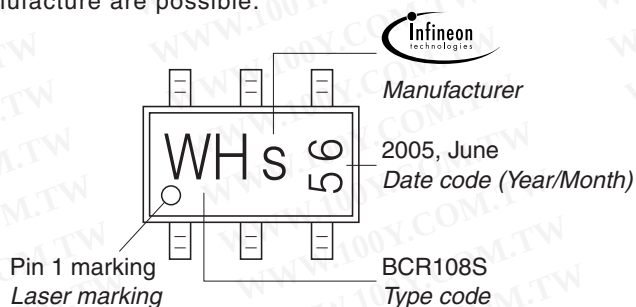


## Foot Print



## Marking Layout (Example)

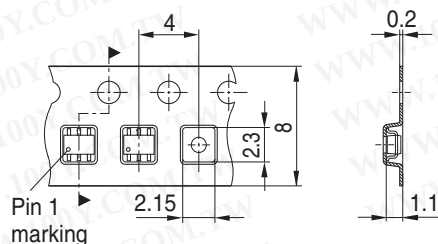
Small variations in positioning of Date code, Type code and Manufacture are possible.



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



**Edition 2009-11-16**

**Published by  
Infineon Technologies AG  
81726 Munich, Germany**

**© 2009 Infineon Technologies AG  
All Rights Reserved.**

勝特力材料 886-3-5753170  
勝特力电子(上海) 86-21-34970699  
勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)

### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

### **Information**

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([<www.infineon.com>](http://www.infineon.com)).

### **Warnings**

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.